

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5812007

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HENG-LI CHIN	11/08/2019
CHIA-HUNG WEI	11/08/2019
WAN-CHEN LIN	11/08/2019
YU-HSIN CHENG	11/08/2019
CHIE-MING CHOU	11/08/2019
RECEIVING PARTY DATA	
Name:	FG Innovation Company Limited
Street Address:	Flat 2623, 26/F Tuen Mun Central Square, 22 Hoi Wing Road, Tuen Mun, New Territories
City:	Tuen Mun
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16678766
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	ALVIN KOAN
SIGNATURE:	/Alvin Koan/
DATE SIGNED:	11/08/2019
Total Attachments: 4	
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ASSIGNMENT

THIS ASSIGNMENT, by:

- 1. HENG-LI CHIN, residing at Taipei, TW
- 2. CHIA-HUNG WEI, residing at Hsinchu,, TW
- 3. WAN-CHEN LIN, residing at Hualien, TW
- 4. YU-HSIN CHENG, residing at Hsinchu, TW
- 5. CHIE-MING CHOU, residing at Hsinchu,, TW

(hereinafter collectively referred to as the "Assignor"), WITNESSETH:

WHEREAS, said Assignor has invented certain new and useful improvements in a:

METHOD AND APPARATUS FOR UPLINK TRANSMISSION

set forth in an application for Letters Patent of the United States,

being executed concurrently herewith; or
 filed on _____, with U.S. Serial No. _____.

WHEREAS,

FG INNOVATION COMPANY LIMITED a corporation duly and lawfully organized, and having a principal place of business at: **Flat 2623, 26/F Tuen Mun Central Square, 22 Hoi Wing Road, Tuen Mun, New Territories, HK**

(hereinafter collectively referred to as the "Assignee").

is desirous of acquiring the entire right, title and interest in and to said inventions and applications for Letters Patent of the United States, and in and to any Letters Patent or Patents, United States or foreign, to be obtained therefore and thereon:

NOW, THEREFORE, in consideration of one Dollar (\$1.00 USD) and other good and sufficient considerations, the receipt of which is hereby acknowledged, said Assignor has sold, assigned, transferred and set over, and by these presents does sell, assign, transfer and set over, unto said Assignee, its successors, legal representatives and assigns, Assignor's interest in the entire right, title and interest in and to the above-mentioned inventions, application for Letters Patent, and any and all Letters Patent or Patents in the United States of America and all foreign countries which may be

granted therefore and thereon, and in and to any and all divisions, continuations, and continuations-in-part of said application, or reissues or extensions of said Letters Patent or Patents, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by said Assignee, for its own use and behalf and the use and behalf of its successors, legal representatives and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted, as fully and entirely as the same would have been held and enjoyed by the Assignor, had this sale and assignment not been made;

AND for the same consideration, said Assignor hereby covenants and agrees to and with said Assignee, its successors, legal representatives and assigns, that, at the time of execution and delivery of these presents, said Assignor is the lawful owner of the entire right, title and interest in and to said invention and the application for Letters Patent above mentioned, and that the same is unencumbered and that said Assignor has good and full right and lawful authority to sell and convey the same in the manner herein set forth;

AND for the same consideration, said Assignor hereby covenants and agrees to and with said Assignee, its successors, legal representatives and assigns, that said Assignor will, whenever counsel of said Assignee, or the counsel of its successors, legal representatives and assigns, shall advise that any proceeding in connection with said inventions, or said application for Letters Patent, or any proceeding in connection with Letters Patent for said inventions in any country, including interference proceedings, is lawful and desirable, or that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue or extension of any Letters Patent, to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of Letters Patent for said inventions, without charge to said Assignee, its successors, legal representatives and assigns, but at the cost and expense of said Assignee, its successors, legal representatives and assigns;

ASSIGNOR(S) does/do hereby authorize ASSIGNEE or its patent agents or attorneys to insert, above, the jurisdictions, application numbers, filing dates and any other indicia identifying the Applications when such information is available for the purpose of recording this assignment.

1.	_____	_____
	HENG-LI CHIN	Date
2.	_____	_____
	CHIA-HUNG WEI	Date
3.	_____	_____
	WAN-CHEN LIN	Date
4.	<u>YU HSIN CHENG</u>	<u>2019.11.8</u>
	YU-HSIN CHENG	Date
5.	_____	_____
	CHIE-MING CHOU	Date